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FORI PTO-1595 (modified)		05-10-	2005	U.S.	DEPARTMENT OF COMMERCE
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Name of person signing		_	Signature		Date

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Total number of pages including cover sheet, attachments, and document: 3

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Assignment

For good and valuable consideration, the receipt of which is hereby acknowledged, I/WE, the undersigned,

Masaki KONDO.

who have created a certain invention for which an application for United States Letters Patent

	executed by ME/US on even date herewith,
	executed by ME/US on,
	(respectively),
\boxtimes	filed on February 4, 2005 and assigned Serial No.
	<u>11/050,437</u> ,
	filed as International Application No.
	filed on_
اختفييا است	and the second s

and entitled:

"SEMICONDUCTOR DEVICE AND METHOD OF FABRICATING THE SAME"

Do hereby sell, assign and transfer to KABUSHIKI KAISHA TOSHIBA, a corporation of Japan, having a place of business at 1-1. Shibaura 1-Chome, Minato-Ku, Tokyo, Japan, its successors, assigns, and legal representatives, the full and exclusive right to said invention and said application and to any and all inventions described in said application for the United States, its territorial possessions and all foreign countries, and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States, its territorial possessions and all foreign countries; and in and to any and all continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, and all other applications for Letters Patent relating thereto which have been or shall be filed in the United States, its territorial possessions and/or any foreign countries, and all rights, together with all priority rights, under any of the international conventions, unions, agreements, acts, and treaties, including all future conventions, unions, agreements, acts, and treaties;

Agree that KABUSHIKI KAISHA TOSHIBA, hereinafter referred to as Assignee, may apply for and receive Letters Patent for said invention and said inventions, hereinafter referred to as said invention, in its own name, in the United States, its territorial possessions, and all foreign countries; and that, when requested to carry out in good faith the intent and purpose of this assignment, at the expense of said Assignee, its successors, assigns and legal representatives, the undersigned will execute all continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, execute all rightful oaths, assignments, powers of attorney and other papers, testify in any legal or quasi legal proceedings; communicate to said Assignee, its successors, assigns or legal representatives all facts known to the undersigned relating to said invention and the history thereof; and generally do everything possible which said Assignee, its successors, assigns, or legal representatives shall consider desirable for aiding in securing, maintaining and enforcing proper patent protection for said invention and for vesting title to said invention and all applications for patents on said invention in said Assignee, its successors, assigns, or legal representatives; and

そして、私/私達は、この書面により譲渡された権利や財産に 影響する、如何なる譲渡、授権、抵当権、ライセンス等その他 の協定も他の第三者との間で行っていないこと; 下記に署名 した私/私達によって、この書面に記載されている権利が所有 されていることを、当該譲受人、後継者、被譲渡者、及び法定 代理人に対して誓約するものである。

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上記を証明するため、私/私達は下記日付で署名する。

Covenant with said Assignee, its successors, assigns, or legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

I/WE, the undersigned do further agree that this Assignment is to be construed solely according to the terms of the English language portions thereof.

IN TESTIMONY WHEREOF I/WE have hereunto set MY/OUR signature seal on the date indicated below.

唯一または第一完明有名		Masaki KONDO	
発明者の署名	日付	Inventor's signature	Date
		Masaki Hondo	April 8, 2005
第二共同発明者(いる場合)		Full name of second joint inventor, if an	y
第二共同発明者の署名	日付	Second Inventor's signature	Date
第三共同発明者(いる場合)		Full name of third joint inventor, if any	
第三共同発明者の署名	日付	Third Inventor's signature	Date
第四共同発明者(いる場合)		Full name of fourth joint inventor, if any	
第四共同発明者の署名	日付	Fourth Inventor's signature	Date
第五共同発明者(いる場合)		Full name of fifth joint inventor, if any	
第五共同発明者の署名	日付	Fifth Inventor's signature	Date
第六共同発明者(いる場合)		Full name of sixth joint inventor, if any	
第六共同発明者の署名	日付	Sixth Inventor's signature	Date
第七共同発明者(いる場合)		Full name of seventh joint inventor, if a	у
第七共同発明者の署名	日付	Seventh Inventor's signature	Date
第八共同発明者(いる場合)		Full name of eighth joint inventor, if any	
第八共同発明者の署名	日付	Eighth Inventor's signature	Date

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